

V_{DSS}	600V
$R_{DS(on)}(Max.)$	0.286Ω
I_D	±18A
P_D	72W

●Features

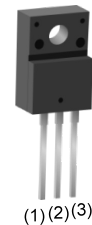
- 1) Fast reverse recovery time (trr)
- 2) Low on-resistance
- 3) Fast switching speed
- 4) Drive circuits can be simple
- 5) Pb-free plating ; RoHS compliant

●Application

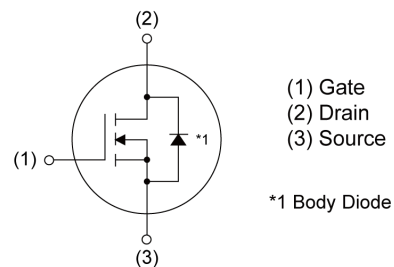
Switching

●Outline

TO-220FM



●Inner circuit



●Packaging specifications

Packing	Tube
Packing code	C7 G
Marking	R6018JNX
Basic ordering unit (pcs)	2000

●Absolute maximum ratings ($T_a = 25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V_{DSS}	600	V
Continuous drain current ($T_c = 25^\circ\text{C}$)	I_D^{*1}	±18	A
Pulsed drain current	I_{DP}^{*2}	±54	A
Gate - Source voltage	V_{GSS}	±30	V
Avalanche current, single pulse	I_{AS}^{*3}	4.4	A
Avalanche energy, single pulse	E_{AS}^{*3}	526	mJ
Power dissipation ($T_c = 25^\circ\text{C}$)	P_D	72	W
Junction temperature	T_j	150	°C
Operating junction and storage temperature range	T_{stg}	-55 to +150	°C

● Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC}	-	-	1.76	°C/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	70	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

● Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	600	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^\circ\text{C}$	-	-	100	μA
Gate - Source leakage current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 4.2mA$	5.0	6.0	7.0	V
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$V_{GS} = 15V, I_D = 9.0A$ $T_j = 25^\circ\text{C}$	-	0.220	0.286	Ω
Gate resistance	R_G	$f = 1MHz, \text{open drain}$	-	1.7	-	Ω

● Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input capacitance	C_{iss}	$V_{GS} = 0V$	-	1300	-	pF
Output capacitance	C_{oss}	$V_{DS} = 100V$	-	70	-	
Reverse transfer capacitance	C_{rss}	$f = 1MHz$	-	1.8	-	
Effective output capacitance energy related	$C_{o(er)}^{*6}$	$V_{GS} = 0V$	-	63	-	
Effective output capacitance time related	$C_{o(tr)}^{*7}$	$V_{DS} = 0V \text{ to } 480V$	-	235	-	ns
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \approx 300V, V_{GS} = 15V$	-	26	-	
Rise time	t_r^{*5}	$I_D = 9.0A$	-	20	-	
Turn - off delay time	$t_{d(off)}^{*5}$	$R_L \approx 33.2\Omega$	-	50	-	
Fall time	t_f^{*5}	$R_G = 10\Omega$	-	12	-	

● Gate charge characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	Q_g^{*5}	$V_{DD} \approx 300V$	-	42	-	nC
Gate - Source charge	Q_{gs}^{*5}	$I_D = 18A$	-	12	-	
Gate - Drain charge	Q_{gd}^{*5}	$V_{GS} = 15V$	-	15	-	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} \approx 300V, I_D = 18A$	-	9.3	-	V

*1 Limited only by maximum temperature allowed.

*2 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*3 $L \approx 50mH$, $V_{DD} = 50V$, $R_G = 25\Omega$, starting $T_j = 25^\circ\text{C}$

*4 $T_c = 25^\circ\text{C}$

*5 Pulsed

*6 $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

*7 $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Source current	I_S^{*1}	$T_C = 25^\circ\text{C}$	-	-	18	A
Pulsed source current	I_{SP}^{*2}		-	-	54	A
Source-Drain voltage	V_{SD}^{*5}	$V_{GS} = 0\text{V}, I_S = 18\text{A}$	-	-	1.7	V
Reverse recovery time	t_{rr}^{*5}	$I_S = 18\text{A}$ $di/dt = 100\text{A}/\mu\text{s}$	-	80	-	ns
Reverse recovery charge	Q_{rr}^{*5}		-	280	-	nC
Peak reverse recovery current	I_{rr}^{*5}		-	7.5	-	A

● Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve



Fig.2 Drain Current Derating Curve vs. Junction Temperature



Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

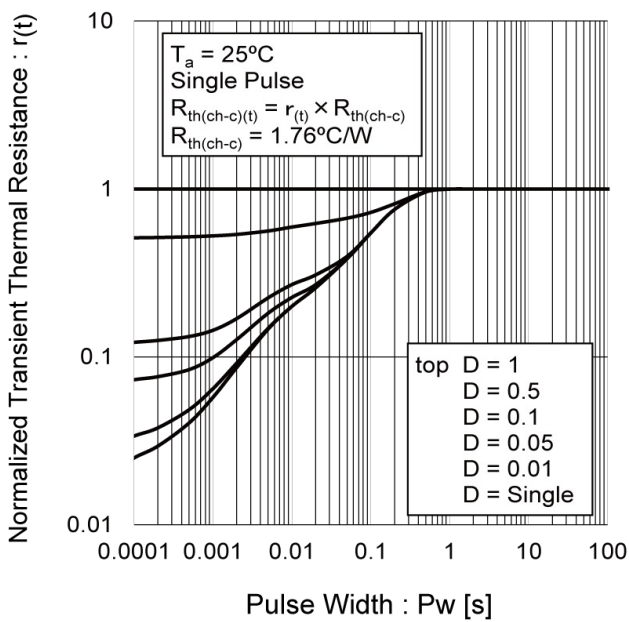
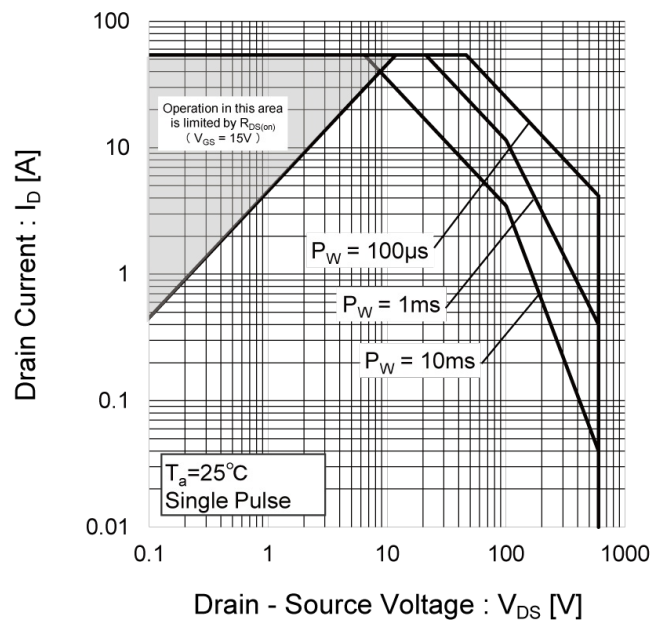


Fig.4 Maximum Safe Operating Area



● Electrical characteristic curves

Fig.5 Avalanche Energy Derating Curve vs. Junction Temperature

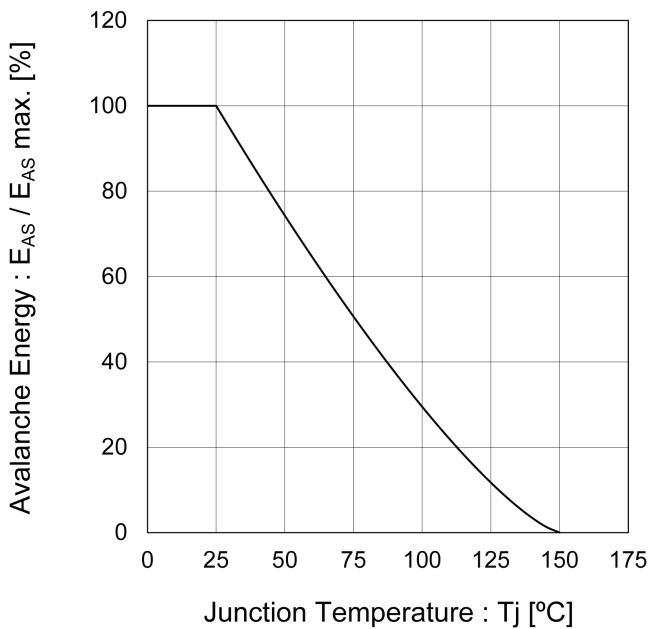


Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

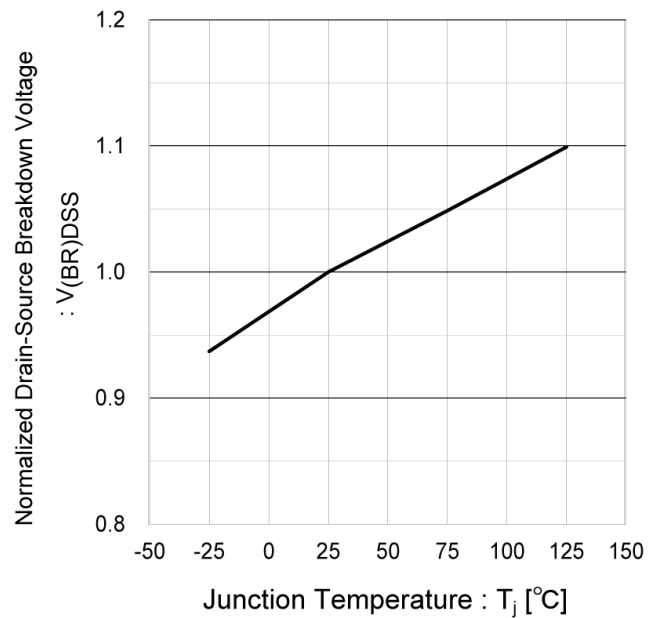


Fig.7 Typical Output Characteristics(I)

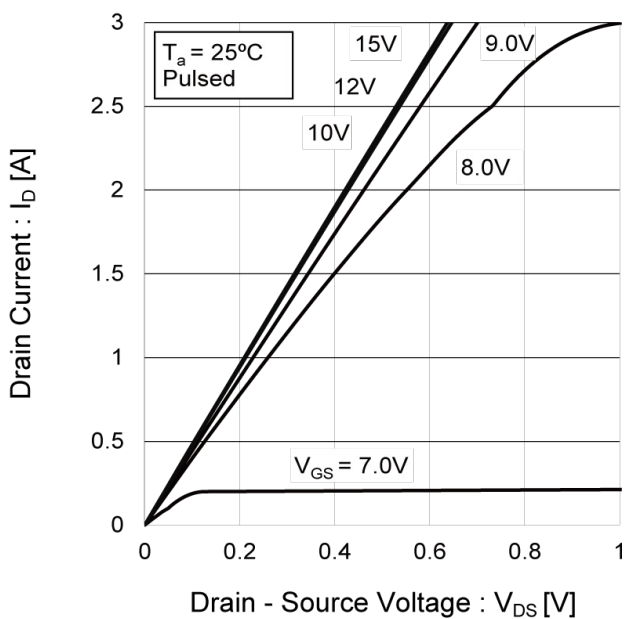
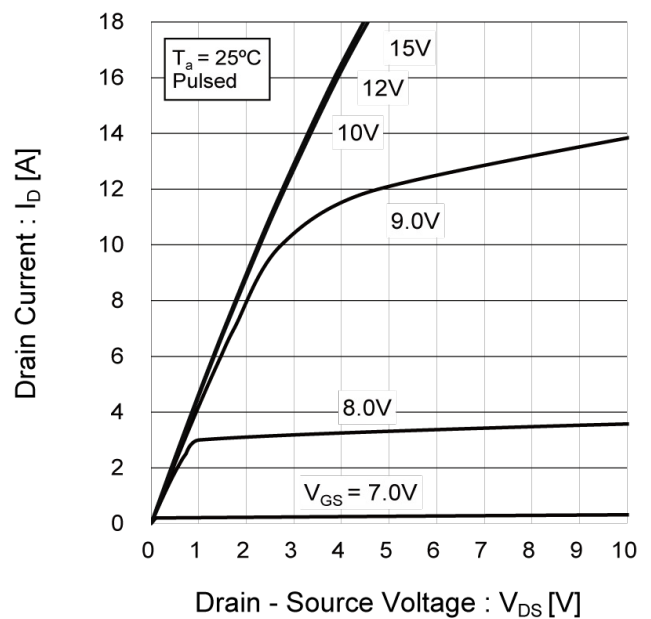


Fig.8 Typical Output Characteristics(II)



● Electrical characteristic curves

Fig.9 Typical Transfer Characteristics

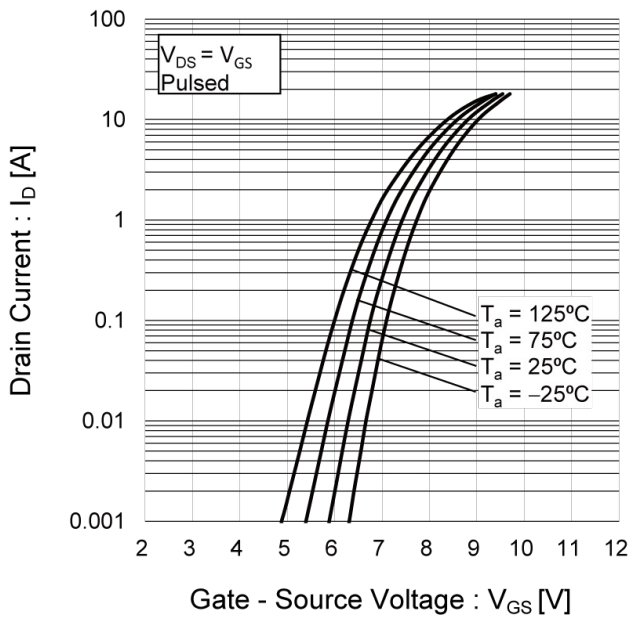


Fig.10 Normalized Gate Threshold Voltage vs. Junction Temperature

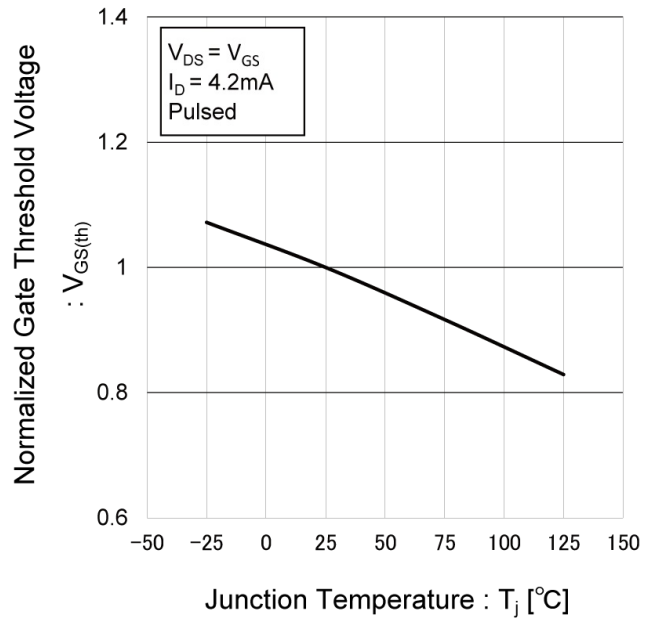


Fig.11 Static Drain - Source On - State Resistance vs. Gate Source Voltage

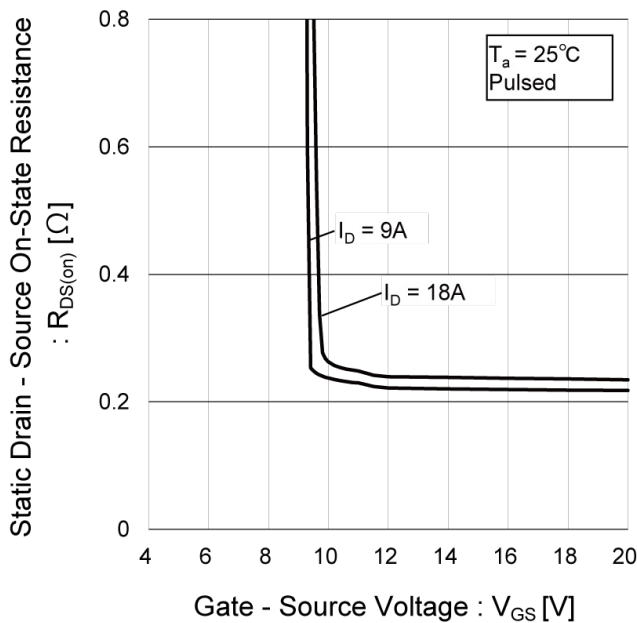
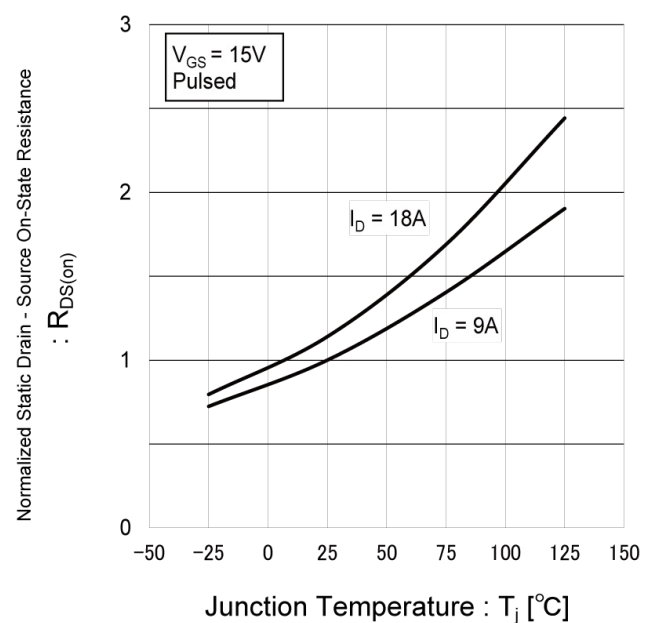


Fig.12 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature



● Electrical characteristic curves

Fig.13 Static Drain - Source On - State Resistance vs. Drain Current

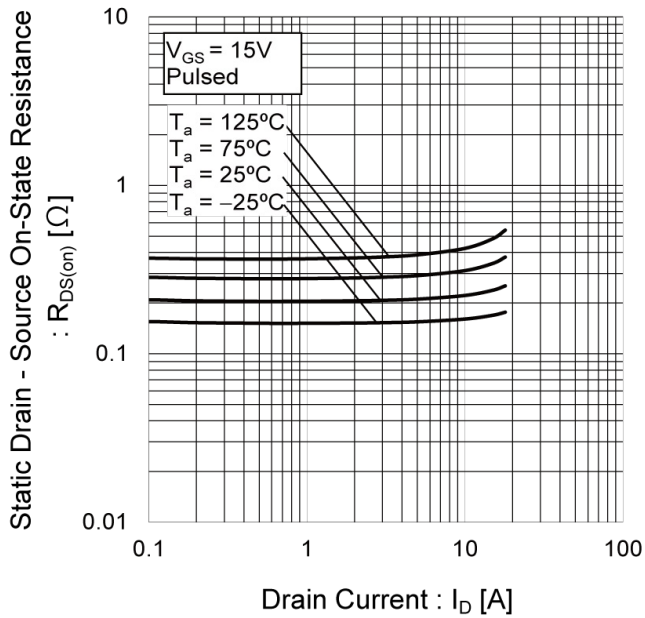


Fig.14 Typical Capacitance vs. Drain - Source Voltage

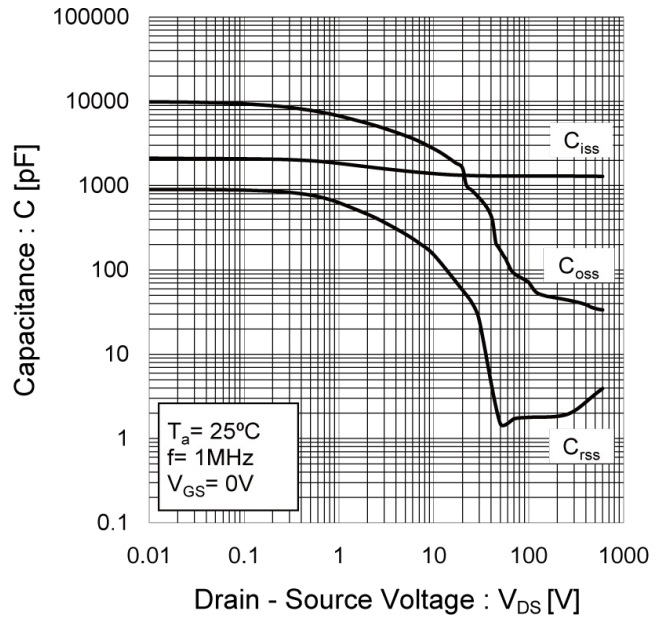


Fig.15 Typical Coss Stored Energy

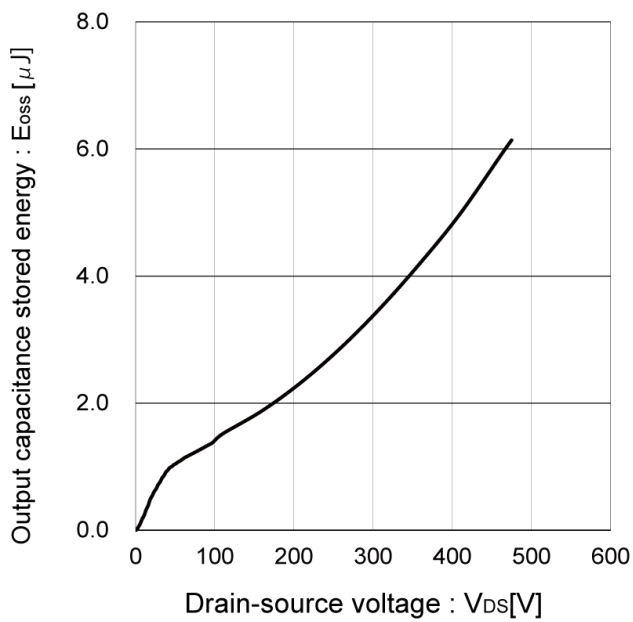
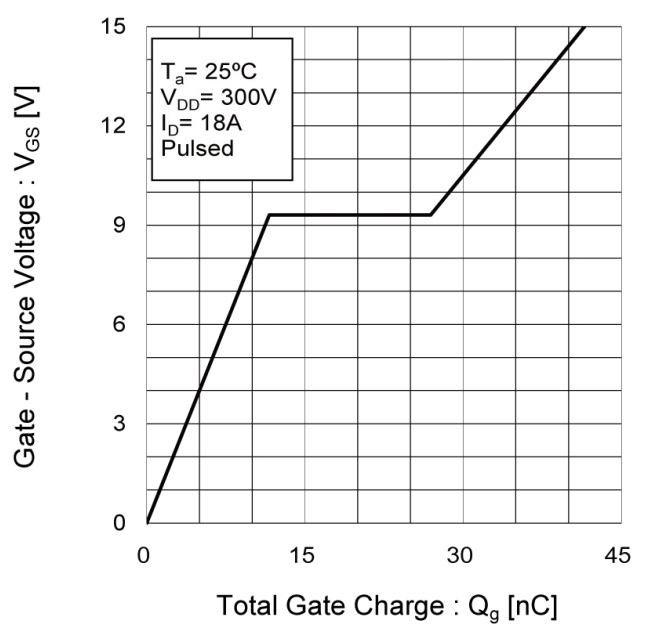


Fig.16 Typical Gate Charge



● Electrical characteristic curves

Fig.17 Inverse Diode Forward Current vs. Source - Drain Voltage

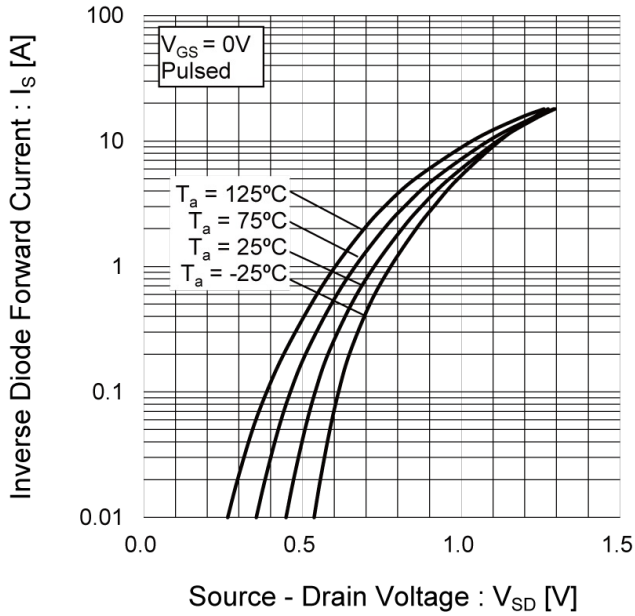
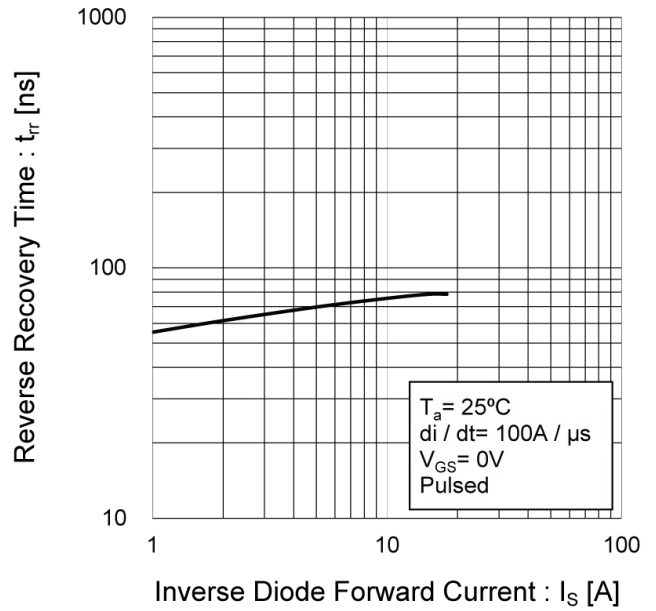


Fig.18 Reverse Recovery Time vs. Inverse Diode Forward Current



● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit



Fig.1-2 Switching Waveforms

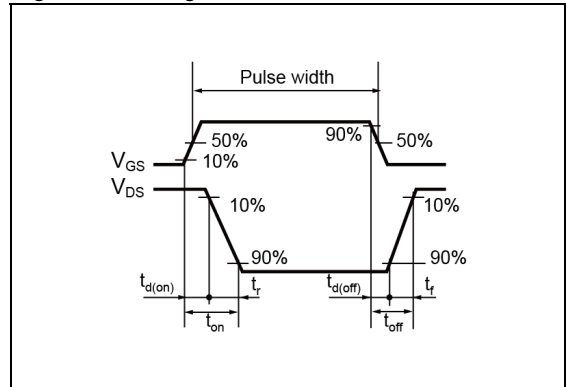


Fig.2-1 Gate Charge Measurement Circuit



Fig.2-2 Gate Charge Waveform



Fig.3-1 Avalanche Measurement Circuit



Fig.3-2 Avalanche Waveform



Fig.4-1 Diode Recovery Measurement Circuit

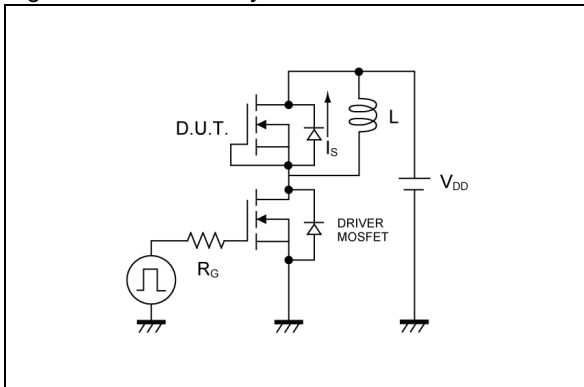
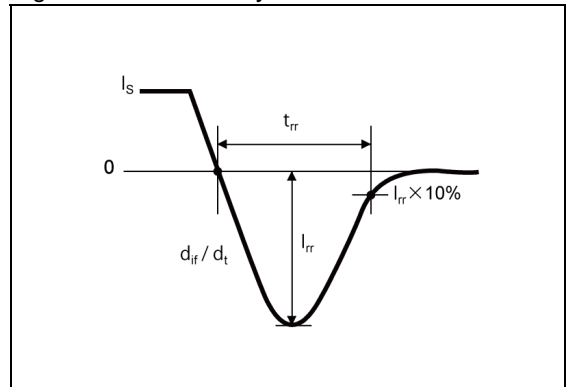
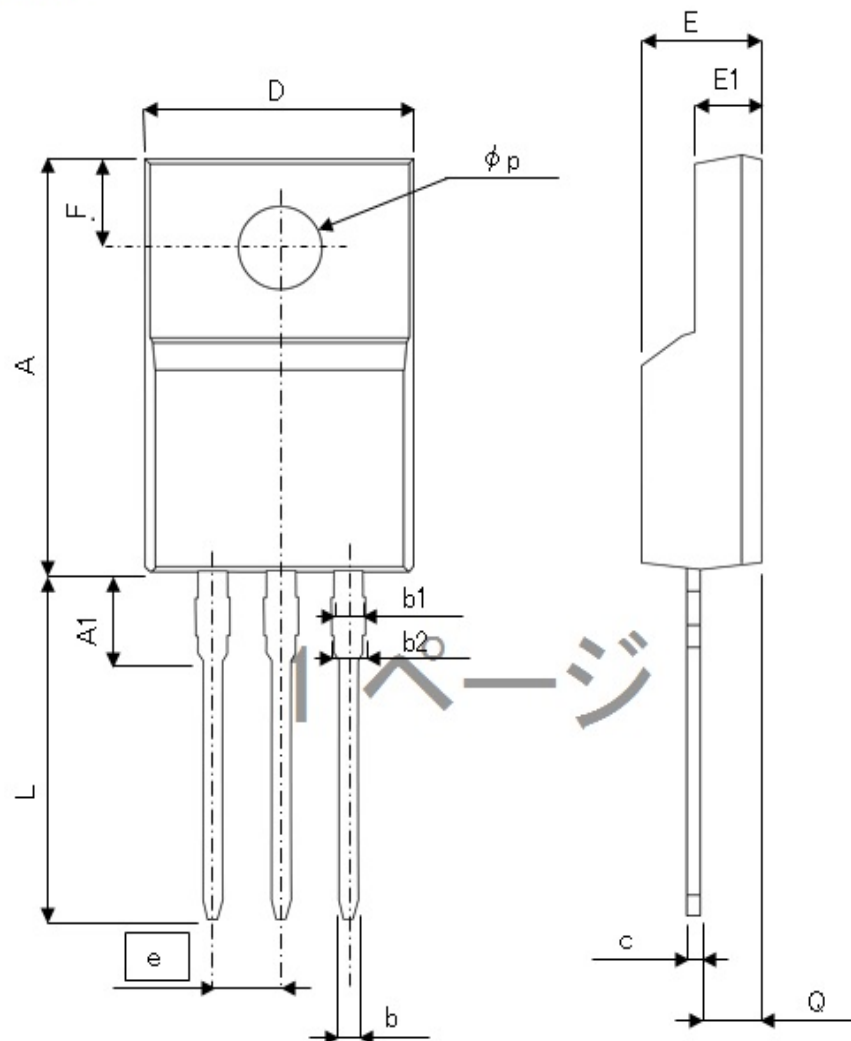


Fig.4-2 Diode Recovery Waveform



●Dimensions

TO-220FM



DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.67	16.27	0.617	0.641
A1	3.03	3.43	0.119	0.135
b	0.70	0.95	0.028	0.037
b1	1.00	1.40	0.039	0.055
b2	1.10	1.50	0.043	0.059
c	0.45	0.65	0.018	0.026
D	9.90	10.30	0.390	0.406
E	4.60	5.00	0.181	0.197
E1	2.44	2.74	0.096	0.108
e	2.54		0.100	
F	3.10	3.50	0.122	0.138
L	12.6	13.6	0.496	0.535
p	2.98	3.38	0.117	0.133
Q	2.25	3.25	0.089	0.128

Dimension in mm / inches

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JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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